Risk Assessment Form

(This is an active document and must be maintained)



Date: September 2018

Materials Science and Metallurgy

Building: MSM Supervisor of Room/Area: Judith Driscoll

Room or area: -1.021, -1.022 -1.023, PLD and prep rooms

(Describe location)

Name of Assessor(s):

Title of Activity / Experiment / Work Area:

Pulsed laser deposition of thin films using Mk-10 chamber with 201 KrF excimer laser

Description of Activity / Experiment / Work Area:

- 1) Cleaning substrates
 - Substrates are cleaned by sonicating in deionized water, acetone and isopropyl-alcohol, and sprayed with an isopropyl-alcohol and N₂ spray until dry.
- 2) Attaching substrate to heater stage
 - Substrates are attached to the heater stage by applying a small (<0.1 ml) amount of silver paste
- 3) Loading heater stage and target flange into vacuum system
 - The heater stage is secured to the side of the chamber by 4 bolts and can be removed without a step stool. The target flange is lifted from the top of the chamber and a step stool is required.
- 4) Pumping vacuum systems
 - The chamber is pumped down to ~1e-4 Pa using a rotary and turbo pump system.
- 5) Heating substrates
 - Substrates are heated up to 750°C for multiple hours inside chamber (heating current <4 A) using a Neocera resistive substrate heater.
- 6) Use of ultraviolet class 4 pulsed laser source (201) to ablate various materials within a vacuum chamber for preparation of thin film samples.
- 7) Annealing substrate in oxygen atmosphere at high temperature
- 8) Removing samples from heater stage
- 9) Cleaning heater stage with isopropyl-alcohol and grit paper

SECTION 1: Identify all significant hazards, who or what may be affected by each individual hazard and controls in place to reduce risk to a minimum.

Hazard Description	Hazard to whom or what	Controls in place to reduce risk to a minimum
1a. Inhalation of solvent vapor	Users, others in room	Cleaning takes place within fume hood
1b. Solvent contact with skin/eyes/mouth	Users	Use nitrile gloves, clean in fume hood
2a. Inhalation of vapors	Users, others in room	Use fume hood
2b. Silver paste skin/eyes/mouth contact	Users	Use nitrile gloves and fume hood
3a. Loading/unloading involves heavy	Users, others nearby in	Training in correct loading technique
lifting, standing on a small step stool for	case of fall	and posture.
target flange. Can injure back or fall.		

4a. Asphyxiation	Everyone in room	Pumps and room contain gas extraction
		system. Oxygen sensors in room.
5a. High temperature of heater	Users	Heater is fully enclosed within chamber
		whenever it is hot.
5b. Electric shock from applied current	Users, others in room	Applied current < 0.4 A. Operational
gov zaveno saven nom upproce current		protocol, wires are not exposed, do not
		adjust cables whilst current is on.
5c. Chambers are hot during substrate	Users, others in room	Training procedures for users in room.
heating	Cools, others in room	Metal frame around base of chamber.
neumg		Chambers are not sufficiently hot to
		cause injury with a short touch.
6a. High voltage inside laser chassis	Operators	High voltage components only opened
od. High voltage histor thasts	Operators	by qualified service engineer.
6b. KrF gas inside chassis	All in room	Flourine gas detection system installed.
ov. Kii gas mside chassis	7 m m room	Use of pre-mixed gases with low F ₂
		concentration.
6c. Unauthorized operation	All in room	Room access restricted by locks to
oc. Chaumorized operation	All III IOOIII	hallway
6d. Beam delivery (normal operations):	All in room	Beam path fully enclosed, interlock
Class 3B laser hazard to eyes and skin	All III Ioolii	system in place. All room users have
inside beam delivery path.		taken laser safety course up to 3B.
6f. Beam delivery (abnormal operations):	All in room	Beam path to be as fully enclosed as
	All III 100III	
Class 4 laser hazard to eyes and skin inside		practicable. Remove any watches or
beam delivery path.		jewelry. Everyone must leave the room when using Class 4 unless they have
		had university Class 4 laser safety
		training and are working on the system
		in question (or being trained). Interlock
		-
		system in place meaning laser will turn
		off if room doors are opened, and
6a I agai magaga (nammal anamatian).	Hoons others in room	warning lights turn on outside the room.
6g. Laser process (normal operation): scattered radiation from target	Users, others in room	Beam path is fully enclosed within
scattered radiation from target		chamber. Interlock systems turn off
7. High average and high temporature	Hanna othona in moom	laser if beam path is opened.
7a. High oxygen and high temperature environment are a fire hazard	Users, others in room	Pressure in chamber kept at or below
environment are a tire nazard		atmospheric pressure
		Chamber is fully enclosed and sealed,
Po Use of a blade to remain semals	Llagra	and is opened until cooled.
8a. Use of a blade to remove sample	Users	User training for blade use
0- 1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1	TT	Dispose of blades in sharps bin
9a. Inhalation of solvent vapor or dust	Users	Use of solvent reduces dry dust build
Ob Colmont/dust	I I a a ma	up. Clean within fume hood.
9b. Solvent/dust contact with	Users	Use nitrile gloves, clean within fume
skin/eyes/mouth		hood.

SECTION 2: Emergency Procedures

Small solvent spill-dilute with water and mop up

Large solvent spill – stop leak if without risk. Evacuate room. Absorb with dry earth/sand. Neutralize with sodium carbonate.

Eye or skin contact with solvent or powder – flush area of contact with plenty of water, remove contact lenses if necessary, contact a First Aider, remove contaminated clothing.

Inhalation of powder or excessive vapor – remove affected user to fresh air, contact a First Aider.

Laser use – shut down laser at rear switch, or remove power via socked on gantry

If gas sensor alarm sounds evacuate room

Signature of Assessor(s)	Date:
Signature of Supervisor	Date:

SECTION 3: Review - This assessment must be reviewed every 12 months or earlier if the basis of the original assessment is altered.

Review Date	Reviewed by (Signature)

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